

DCR820N65

Phase Control Thyristor



DS5923-4 August 2014(LN 31845)

FEATURES

- Double Side Cooling
- High Surge Capability

APPLICATIONS

- Medium Voltage Soft Starts
- High Voltage Power Supplies
- Static Switches

VOLTAGE RATINGS

Part and Ordering Number	Repetitive Peak Voltages V _{DRM} and V _{RRM} V	Conditions
DCR820N65* DCR820N60 DCR820N55 DCR820N50	6500 6000 5500 5000	$\begin{split} T_{vj} = -40^{\circ}\text{C to } 125^{\circ}\text{C}, \\ I_{DRM} = I_{RRM} = 200\text{mA}, \\ V_{DRM}, V_{RRM} t_p = 10\text{ms}, \\ V_{DSM} \& V_{RSM} = \\ V_{DRM} \& V_{RRM} + 100V \\ respectively \end{split}$

Lower voltage grades available. 6200V @ -40° C, 6500V @ 0° C

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

DCR820N65

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.

KEY PARAMETERS

6500V
820A
12000A
1500V/µs
200A/μs

* Higher dV/dt selections available

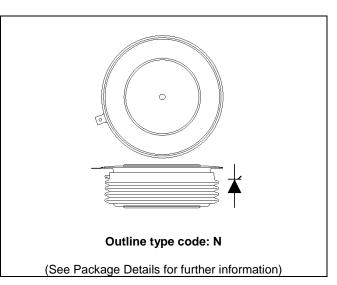


Fig. 1 Package outline





CURRENT RATINGS

T_{case} = 60°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Double Si				
I _{T(AV)}	Mean on-state current	Half wave resistive load	820	А
I _{T(RMS)}	RMS value	-	1288	А
I _T	Continuous (direct) on-state current	-	1090	А

SURGE RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
I _{TSM}	Surge (non-repetitive) on-state current	10ms half sine, T _{case} = 125°C	12.0	kA
l ² t	I ² t for fusing	$V_R = 0$	0.72	MA ² s

THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions		Min.	Max.	Units
R _{th(j-c)}	Thermal resistance – junction to case	Double side cooled	DC	-	0.0221	°C/W
		Single side cooled	Anode DC	-	0.041	°C/W
			Cathode DC	-	0.0516	°C/W
R _{th(c-h)}	Thermal resistance – case to heatsink	Clamping force 23 kN	Double side	-	0.004	°C/W
		(with mounting compound)	Single side	-	0.008	°C/W
T _{vj}	Virtual junction temperature	Blocking V _{DRM} / _{VRRM}		-	125	°C
T _{stg}	Storage temperature range			-55	125	°C
F _m	Clamping force			20.0	25.0	kN





DYNAMIC CHARACTERISTICS

Symbol	Parameter	Test Conditio	Test Conditions		Max.	Units
I _{RRM} /I _{DRM}	Peak reverse and off-state current	At V _{RRM} /V _{DRM} , T _{case} = 125°C		-	200	mA
dV/dt	Max. linear rate of rise of off-state voltage	To 67% V _{DRM} , T _j = 125°C, ga	ate open	-	1500	V/µs
dl/dt	Rate of rise of on-state current	From 67% V _{DRM} to 2x I _{T(AV)}	Repetitive 50Hz	-	100	A/µs
		Gate source 30V, 10Ω,	Non-repetitive	-	200	A/µs
		$t_r < 0.5 \mu s, T_j = 125 ^{\circ} C$				
V _{T(TO)}	Threshold voltage – Low level	100A to 870A at T _{case} = 125°	С	-	1.0	V
	Threshold voltage – High level	870A to 3000A at T _{case} = 125	5°C	-	1.1847	V
r _T	On-state slope resistance – Low level	100A to 870A at T _{case} = 125°	С	-	1.1429	mΩ
	On-state slope resistance – High level	870A to 3000A at T _{case} = 125°C		-	0.9472	mΩ
t _{gd}	Delay time	$V_D = 67\% V_{DRM}$, gate source 30V, 10Ω		-	3	μs
	,	t _r = 0.5μs, T _j = 25°C				
tq	Turn-off time	T_j = 125°C,I _{peak} = 1000A, t_p = 1000us, V_{RM} = 100V, dI/dt = -5A/ μ s,		600	1000	μs
		dV _{DR} /dt = 20V/µs linear to 25	500V			
I _{RR}	Reverse recovery current	$I_T = 1000A$, $t_p = 1000us$, $T_i = 125$ °C,		90	120	А
Qs	Stored charge	$dI/dt = -5A/\mu s$, $V_R = 100V$		2500	4000	μC
IL	Latching current	$T_j = 25^{\circ}C, V_D = 5V$		-	3	А
I _H	Holding current	$T_j = 25^{\circ}C, R_{G-K} = \infty, I_{TM} = 500$	0A, I _T = 5A	-	300	mA



GATE TRIGGER CHARACTERISTICS AND RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
V_{GT}	Gate trigger voltage	V _{DRM} = 5V, T _{case} = 25°C	1.5	V
V_{GD}	Gate non-trigger voltage	At 50% V _{DRM} , T _{case} = 125°C	0.4	V
I _{GT}	Gate trigger current	$V_{DRM} = 5V$, $T_{case} = 25$ °C	350	mA
I _{GD}	Gate non-trigger current	At 50% V _{DRM} , T _{case} = 125°C	15	mA

CURVES

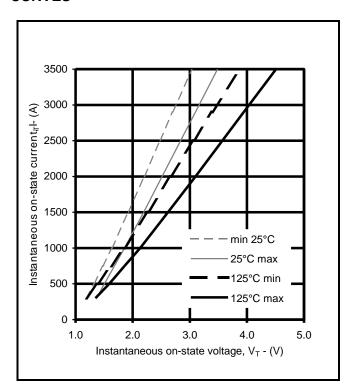


Fig.2 Maximum & minimum on-state characteristics

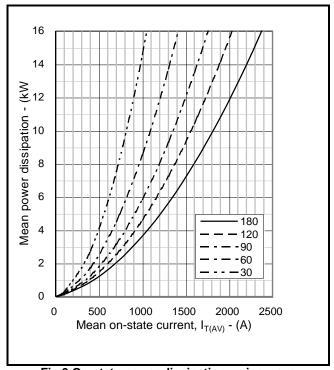
 V_{TM} EQUATION Where A = 0.874878 B = 0.001945

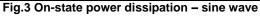
 $V_{TM} = A + Bln (I_T) + C.I_T + D.\sqrt{I_T}$ C = 0.000808

D = 0.013372

these values are valid for $T_j = 125$ °C for $I_T 300$ A to 3500A







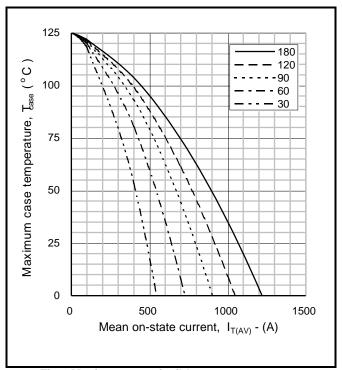


Fig.4 Maximum permissible case temperature, double side cooled – sine wave

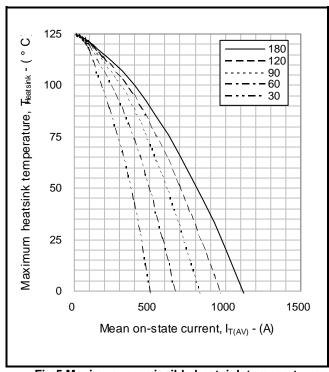


Fig.5 Maximum permissible heatsink temperature, double side cooled – sine wave

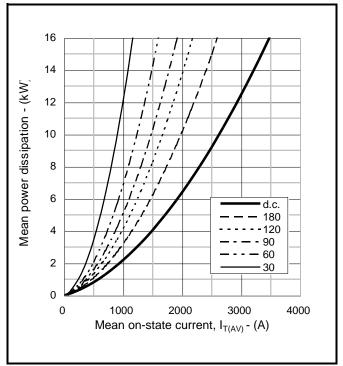
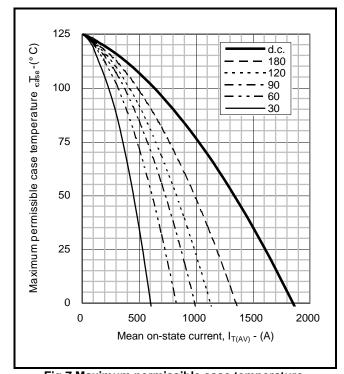
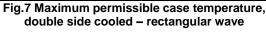


Fig.6 On-state power dissipation - rectangular wave







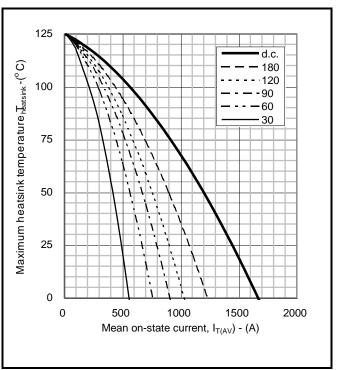
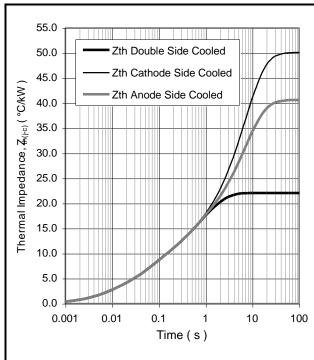


Fig.8 Maximum permissible heatsink temperature, double side cooled – rectangular wave



		1	2	3	4
Double side cooled	R _i (°C/kW)	3.4733	4.9047	9.1463	4.5220
	T _i (s)	0.1457	0.0166	1.2832	0.3767
Anode side cooled	R _i (°C/kW)	7.6674	5.0530	9.7355	27.5992
	T _i (s)	0.2241	0.0169	4.0566	8.2780
Cathode side cooled	R _i (°C/kW)	6.0393	4.2782	5.1301	25.0874
	T _i (s)	0.1356	0.0143	0.6594	7.2358

$$Z_{th} = \sum_{i=1}^{i=4} [R_i \times (1 - \exp(T/T_i))]$$

$\Delta R_{th(j-c)}$ Conduction

Tables show the increments of thermal resistance $R_{\text{th}(j-c)}$ when the device operates at conduction angles other than d.c.

	Double side cooling				
	ΔZ_{th} (z)				
θ°	sine.	rect.			
180	3.03	2.07			
120	3.49	2.95			
90	3.99	3.43			
60	4.43	3.94			
30	4.77	4.49			
15	4.00	1 77			

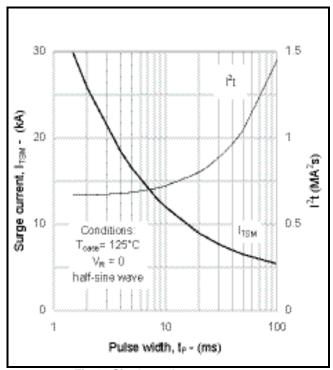
	Anode Side Cooling			
	ΔZ_t	_h (z)		
θ°	sine.	rect.		
180	3.03	2.07		
120	3.49	2.95		
90	3.99	3.43		
60	4.43	3.94		
30	4.76	4.48		
15	4.92	4.77		

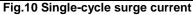
	ΔZ_{th} (z)			
θ°	sine.	rect.		
180	3.12	2.12		
120	3.61	3.04		
90	4.13	3.54		
60	4.60	4.08		
30	4.96	4.66		
15	5.13	4.97		
90 60 30	4.13 4.60 4.96	3.54 4.08 4.66		

Cathode Sided Cooling

Fig.9 Maximum (limit) transient thermal impedance – junction to case (°C/kW)







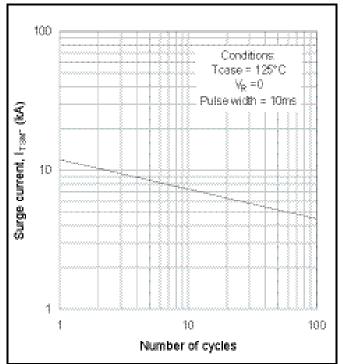


Fig.11 Multi-cycle surge current

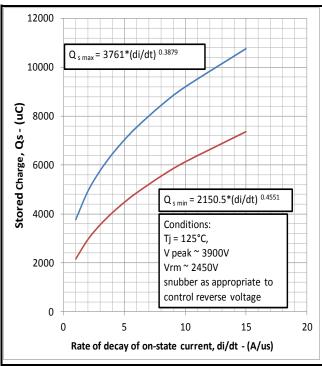


Fig.12 Stored charge

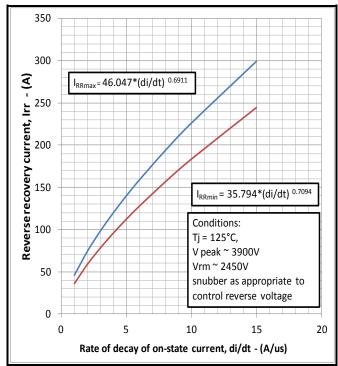


Fig.13 Reverse recovery current

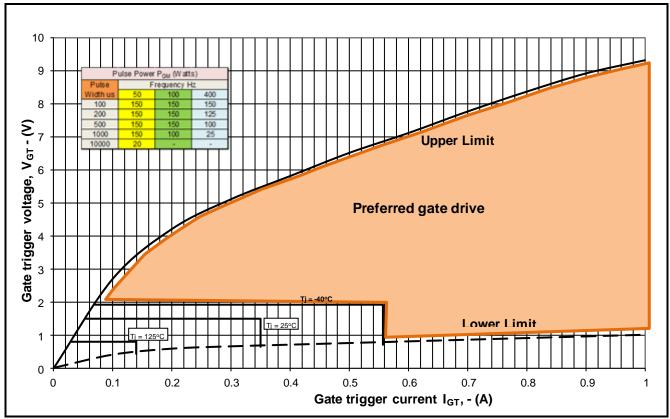


Fig14 Gate Characteristics

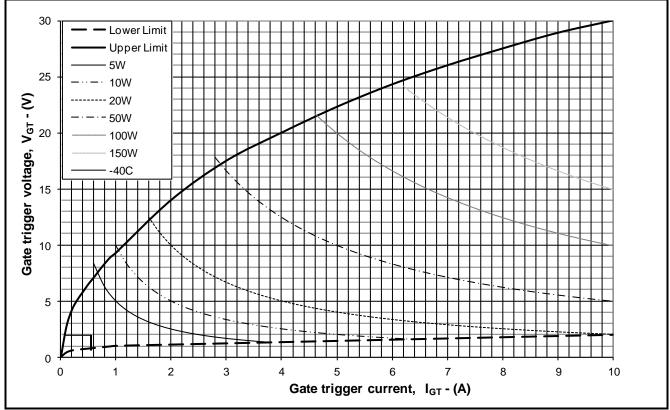


Fig. 15 Gate characteristics

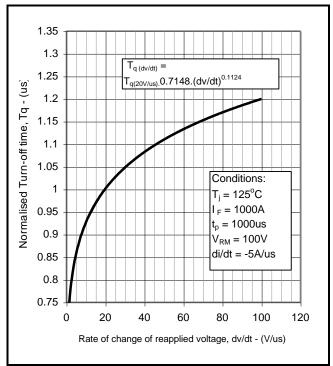


Fig.16 Turn-off time



PACKAGE DETAILS

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.

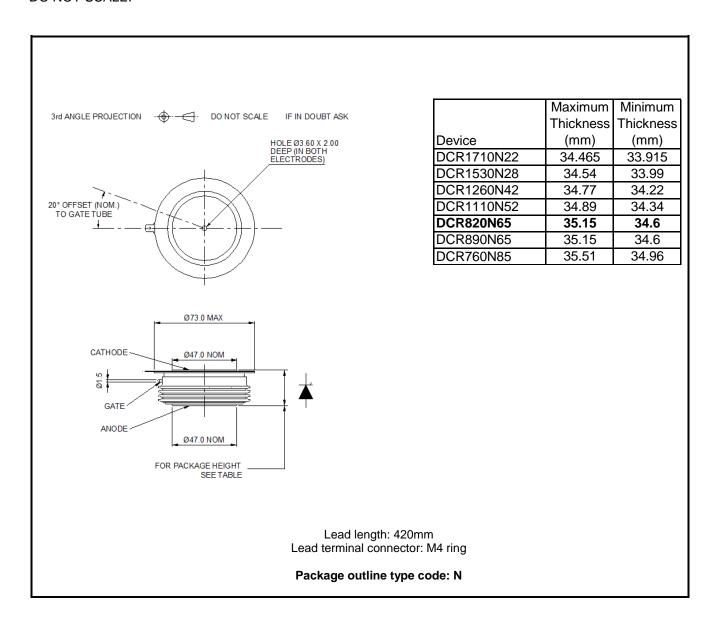


Fig.17 Package outline





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